# **INTEGRATED CIRCUITS**

# DATA SHEET



**74F3040** Dual 4-input NAND 30  $\Omega$  line driver

Product specification IC15 Data Handbook

1990 Jan 29





# **Dual 4-input NAND 30** $\Omega$ line driver

74F3040

#### **FEATURES**

- 30Ω line driver
- 160mA output drive capability in the Low state
- 67mA output drive capability in the High state
- High speed
- Facilitates incident wave switching
- 3nh lead inductance each on V<sub>CC</sub> and GND when both side pins are used

#### **DESCRIPTION**

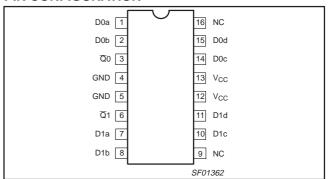
The 74F3040 is a high current Line Driver composed of two 4-input NAND gates. It has been designed to deal with the transmission line effects of PC boards which appear when fast edge rates are used.

The drive capability of the 74F3040 is 67mA source and 160mA sink with a  $V_{CC}$  as low as 4.5V. This guarantees incident wave switching with  $V_{OH}$  not less than 2.0V and  $V_{OL}$  not more than 0.8V while driving impedances as low as  $30\Omega.$  This is applicable with any combination of outputs using continuous duty.

The propagation delay of the part is minimally affected by reflections when terminated only by the TTL inputs of other devices.

Performance may be improved by full or partial line termination.

#### **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F3040	2.0ns	10mA

#### ORDERING INFORMATION

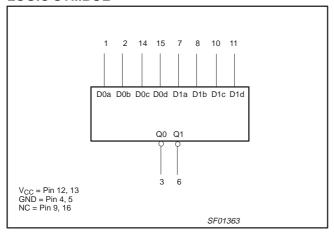
-	DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PACKAGE DRAWING NUMBER
١	16-pin Plastic DIP	N74F3040N	SOT38-4
	16-pin Plastic SOL	N74F3040D	SOT162-1

#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

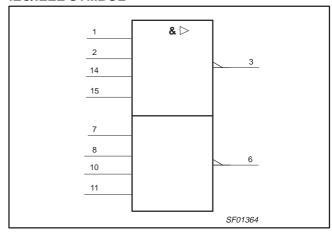
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb, Dnc, Dnd	Data inputs	1.0/1.0	20μA/0.6mA
Qn	n Data outputs		67mA/160mA

NOTE: One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

#### **LOGIC SYMBOL**



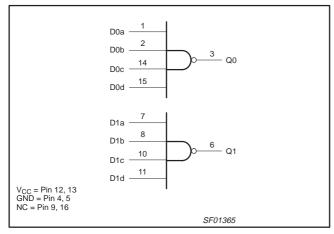
#### **IEC/IEEE SYMBOL**



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#### **LOGIC DIAGRAM**



#### **FUNCTION TABLE**

	INP	OUTPUT		
Dna	Dnb	Dnc	Dnd	Qn
L	Х	Х	Х	Н
Х	L	Х	Х	Н
Х	Х	L	Х	Н
Х	Х	Х	L	н
н	Н	Н	Н	L

H = High voltage level
L = Low voltage level

X = Don't care

(Operation beyond the limits set forth in this table may impair the useful life of the device.

Unless otherwise noted these limits are over the operating free-air temperature reason.

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	$-0.5$ to $V_{CC}$	V
I <sub>OUT</sub>	Current applied to output in Low output state	320	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT		
STWIBUL	PARAMETER	MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-67	mA
I <sub>OL</sub>	Low-level output current			160	mA
T <sub>amb</sub>	Operating free-air temperature range	0		+70	°C

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	DADAMETED		_	TEST CONDITIONS	<b>\1</b>		LIMITS		UNIT
SYMBOL	PARAMETER			IEST CONDITIONS	MIN	TYP <sup>2</sup>	MAX	UNII	
			V <sub>CC</sub> = MIN	1 - 45mA	±10% V <sub>CC</sub>	2.5			V
V <sub>OH</sub>	High-level output current		$V_{IL} = MAX$	I <sub>OH</sub> = -45mA	±5% V <sub>CC</sub>	2.7	3.4		V
			$V_{IH} = MIN$	$I_{OH1} = -67 \text{mA}^3$	±10% V <sub>CC</sub>	2.0			V
V	V <sub>OL</sub> Low-level output current		$V_{CC} = MIN$ $V_{IL} = MAX$	I <sub>OL</sub> = 100mA	±10% V <sub>CC</sub>		0.30	0.50	V
VOL			V <sub>IH</sub> = MIN	I <sub>OL1</sub> = 160mA <sup>4</sup>	±5% V <sub>CC</sub>		0.30	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V	
II	Input current at maximun voltage	n input	\	$V_{CC} = MAX, V_{I} = 7.0$	)V			100	μА
I <sub>IH</sub>	High-level input current		\	$V_{CC} = MAX, V_{I} = 2.7$	V			20	μΑ
I <sub>IL</sub>	Low-level input current		V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5V		<u></u>		-0.6	mA	
I <sub>O</sub>	Output current <sup>5</sup>		$V_{CC} = MAX, V_O = 2.25V$		-100		-200	mA	
1	Supply current (total)  I <sub>CCL</sub>		V - MAY		-11	3.0	5.0	mA	
Icc			V <sub>CC</sub> = MAX				16	22	mA

#### NOTES:

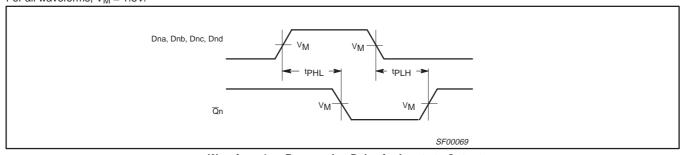
- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25$ °C.
- All typical values are at v<sub>CC</sub> = 5v, 1<sub>amb</sub> = 25 c.
   I<sub>OH1</sub> is the current necessary to guarantee the Low-to-High transition in a 30Ω transmission line on the incident wave.
   I<sub>OL1</sub> is the current necessary to guarantee the High-to-Low transition in a 30Ω transmission line on the incident wave.
   I<sub>O</sub> is tested under conditions that produce current approximately one half of the true short-circuit output current (I<sub>OS</sub>).

#### AC ELECTRICAL CHARACTERISTICS

					LIM	ITS			
SYMBOL	PARAMETER	PARAMETER TEST CONDITION		<sub>mb</sub> = +25 <sub>CC</sub> = +5.0 0pF, R <sub>L</sub> =	V	$T_{amb} = 0^{\circ}C \text{ to } +70^{\circ}C$ $V_{CC} = +5.0V \pm 10\%$ $C_{L} = 50pF, R_{L} = 500\Omega$		UNIT	
			MIN	TYP	MAX	MIN	MAX		
t <sub>PLH</sub>	Propagation delay Dna, Dnb, Dnc, Dnd to Qn	Waveform 1	1.0 1.0	2.0 2.0	5.0 4.5	1.0 1.0	5.5 5.0	ns	

#### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.5V$ .



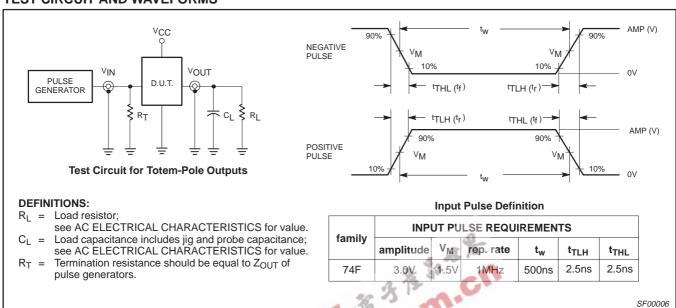
Waveform 1. Propagation Delay for Inputs to Output

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#### **TEST CIRCUIT AND WAVEFORMS**



EFRA

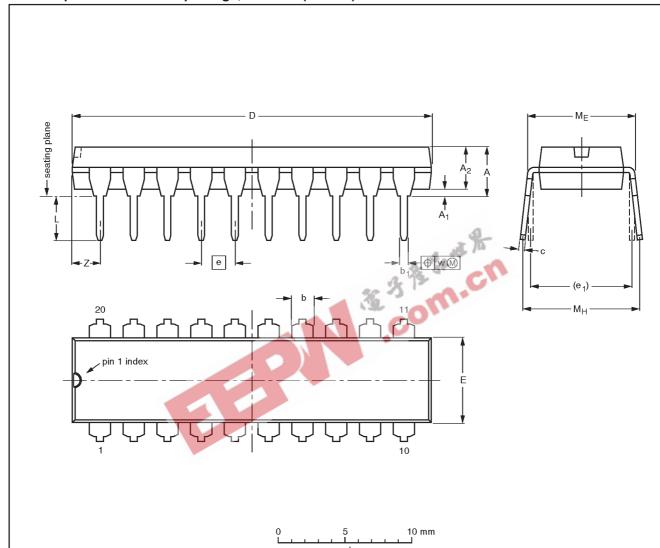
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### DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

DIMENTOR	•														
UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT146-1			SC603			<del>92-11-17</del> 95-05-24

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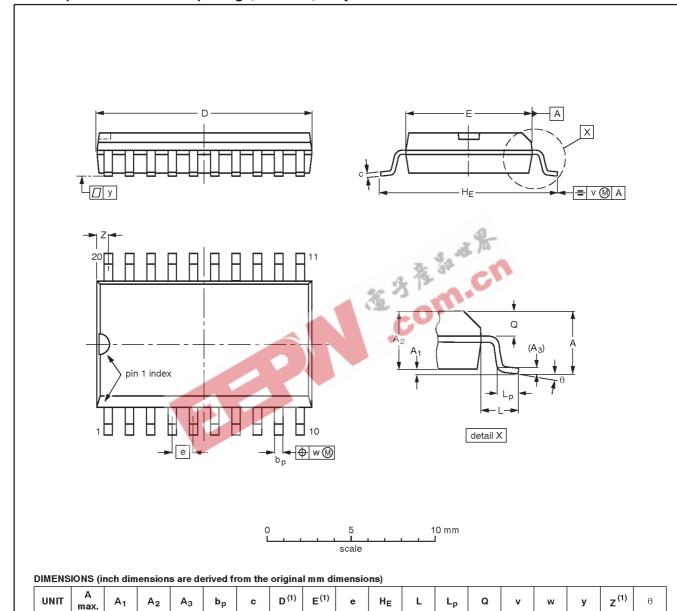
#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

0.9

0.4

0.035



#### Note

inches

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

0.25

0.01

0.49

0.36

0.019

0.32

0.23

0.013

2.45 2.25

0.096

0.30

0.10

0.012

0.004

2.65

0.10

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013AC			<del>-92-11-17</del> 95-01-24	

1.27

0.050

10.65

10.00

0.42

0.055

1.1

1.0

0.043

0.4

0.043

0.25

0.01

0.25

0.01

0.004

13.0

12.6

0.51

7.6

7.4

0.30

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date.  Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

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